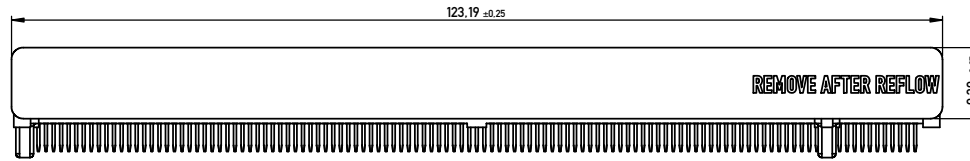
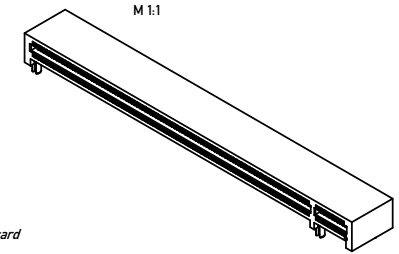
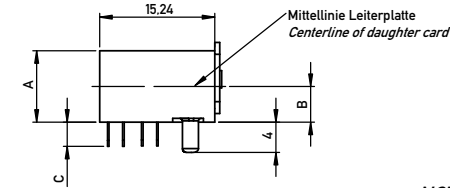
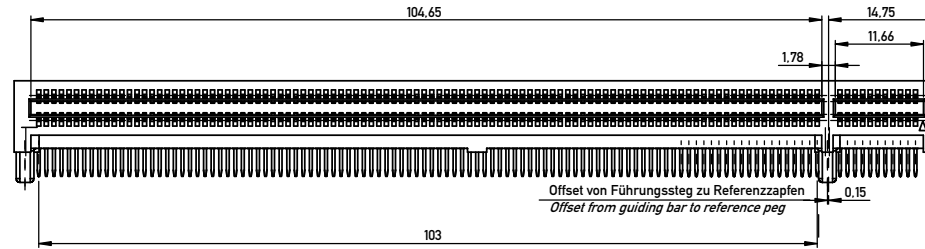
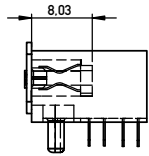


view with dust cover



Detail contact area



NOTES:

Material: LCP GF 30 schwarz
Material: LCP GF 30 black

Galvanik: min. 1.27 µm Unternickelung
über gesamten PIN - Bereich
Gold - Flash im Lötbereich
Plating: min. 1.27 µm Ni entire contact
Gold - Flash plating on contact tails

1.) Fertiglochdurchmesser
finished viadiameter (PTH)

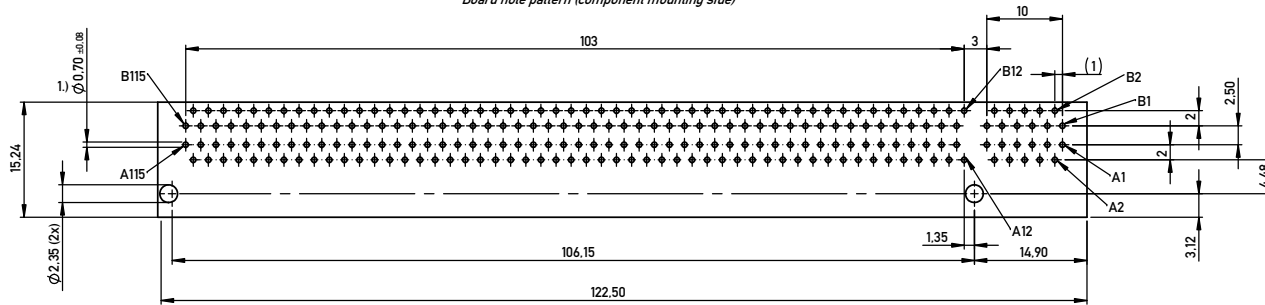
Package: Tray (20 pcs.)

Connector printing / labeling:
according to drawing 294775

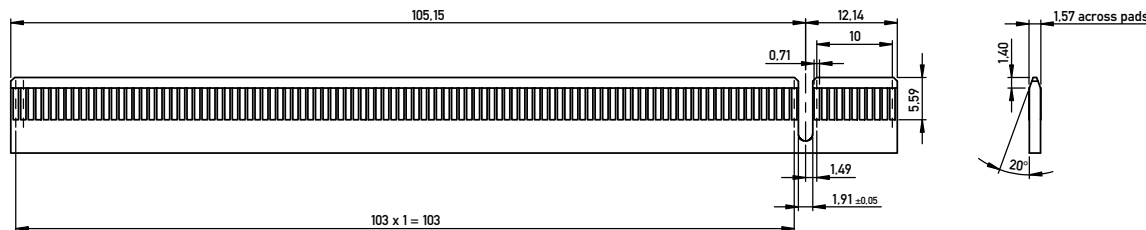
Datum
Date code (see notes)



Lochbild für Leiterplatte (Bestückungsseite)
Board hole pattern (component mounting side)



daughter card layout



Layout proposal is in accordance with the PCI Express spezifikation.

85 Ohm	009824	14,7	11.18	3,18	min. 0,8 µm Au
	009724	14,7	11.18	3,18	min. 0,127 µm Au
	009624	14,7	11.18	2,54	min. 0,8 µm Au
	009524	14,7	11.18	2,54	min. 0,127 µm Au
	009424	9,4	5,84	3,18	min. 0,8 µm Au
	009324	9,4	5,84	3,18	min. 0,127 µm Au
	009224	9,4	5,84	2,54	min. 0,8 µm Au
	009124	9,4	5,84	2,54	min. 0,127 µm Au
Ident.-Nr. Part - No.	Maß "A" Dim "A"	Maß "B" Dim "B"	Maß "C" Dim "C"	Oberfläche Steckbereich plating contact area	

Information / Tolerances: Sofern nichts anderes angegeben / unless otherwise notes			Tolerances	Scale	2:1	Designation	
.x ±0	.xx ±0.127	.xxx ±0.05	All Dimensions in mm	Subject to modification without prior notice. Drawing will not be updated.		Abgew. PCI Express STV 230pol. RT Angle PCI Express 230 pins	
All rights reserved. Only for Information. To ensure that this is the latest version of this drawing, please contact one of the ERNI companies before using.			ERNI	www.ERNI.com		484099	I A2
Index	Date		Class		PCIEXP		